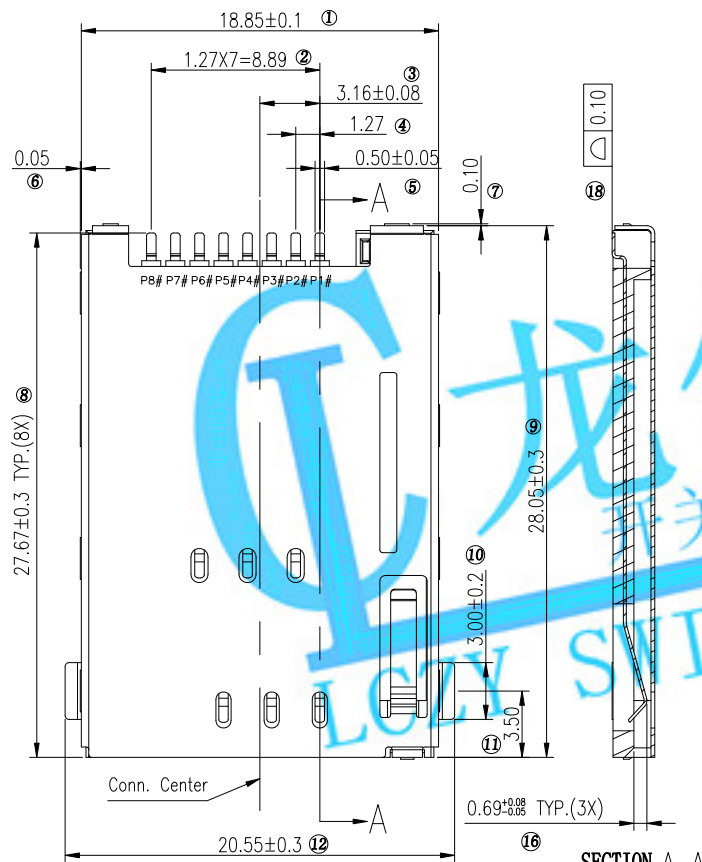
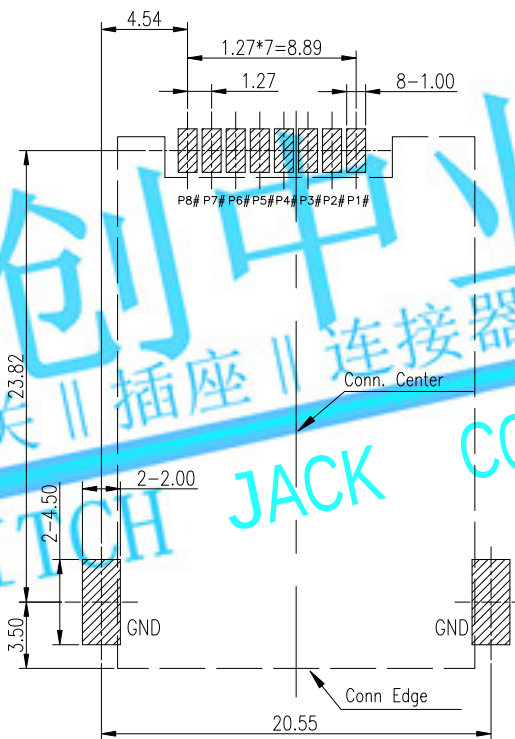




SECTION A-A



RECOMMENDED PCB LAYOUT(TOP VIEW)

GENERAL TOLERANCES:±0.05

 SOLDER AREA



NOTES:

MATERIAL:

Insulator: High Temperature Thermoplastic,UL 94V-0.
Contact: Copper Alloy
Shell: STAINLESS

PLATING:

Contact: Plated 30u'' Ni Overall Contact Au 1U
Shell: Plated 30u'' Ni Overall
Plated 1u''Au Selective Contact Area

Electrical:

Current Rating : 1.0 A AC/DC max.
Voltage Rating : 30V AC/DC
Ambient Temperature Range :-20° C~+60° C
Storage Temperature Range :-40° C~+70° C
Ambient Humidity Range :95% R.H. Max.
Contact Resistance:100mΩmax.
Insulation Resistance:1000MΩmin./500VDC
Mating Cycles: 3000Insertions
Temperature: 260° C ±5°

龙创中业电子科技(东莞)有限公司



DATE 2014/3/27

TOLERANCES UNLESS	
X. ± 0.50	X° ± 3'
.X ± 0.38	.X° ± 2'
.XX ± 0.25	.XX° ± 1'
.XXX ± 0.10	.XXX° ± 0.5'

TITLE:
产品名称 SIM PUSH 6+2P H2.2
PART-NUMBER:
零件编号 LCZY-102031022
DRAWING-NUMBER:
图纸编号

UNIT 单位 mm	DESIGNED 设计 罗正富
SCALE 比例 1:1	CHECKED 核准 罗利斌
SHEET 页码 1/1	APPROVED 审批 张华宇